

Product Summary

V _{(BR)DSS}	V _{(BR)DSS} R _{DS(on)TYP}	
100V	90mΩ@10V	10A
	100mΩ@4.5V	IUA



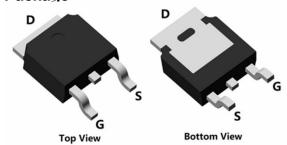
Feature

- Fast Switching
- Low Gate Charge and Rdson
- 100% Single Pulse avalanche energy Test

Applications

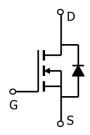
- DC-DC Converter
- Load Switching

Package



TO-252(1:G 2:D 3:S)

Circuit diagram



Marking



SP010N90TH

:Device Code :Week Code

Order Information

Device	Package	Unit/Tape		
SP010N90TH	TO-252	2500		

100V N-Channel MOSFET

Absolute maximum ratings (Ta=25°C,unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V _{DS}	100	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current (T _C =25°C)	ID	10	Α
Continuous Drain Current (T _C =100°C)	I _D	7	А
Pulsed Drain Current	I _{DM}	40	Α
Single Pulse Avalanche Energy ¹	Eas	12	mJ
Power Dissipation (T _C =25°C)	P _D	50	W
Thermal Resistance Junction-to-Case	R _{θJC}	2.5	°C/W
Storage Temperature Range	T _{STG}	-55 to 150	$^{\circ}$ C
Operating Junction Temperature Range	T _J	-55 to 150	$^{\circ}$ C

Electrical characteristics (Ta=25°C, unless otherwise noted)

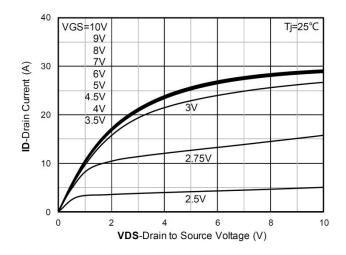
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Static Characteristics	Static Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	VGS=0V , ID=250uA		-	-	V	
Drain-Source Leakage Current	I _{DSS}	VDS=80V , VGS=0V , TJ=25℃		-	1	uA	
Gate-Source Leakage Current	Igss	VGS=±20V , VDS=0V		-	±100	nA	
Gate Threshold Voltage	V _{GS(th)}	VGS=VDS , ID =250uA	1.0	1.6	2.5	V	
0.1. 0.0 0.0 0.1		VGS=10V , ID=10A	-	90	110	mΩ	
Static Drain-Source On-Resistance	R _{DS(ON)}	VGS=4.5V , ID=8A	-	100	120		
Dynamic characteristics							
Input Capacitance	C _{iss}		-	845	-		
Output Capacitance	Coss	VDS=50V , VGS=0V , f=1MHz	-	30	-	pF	
Reverse Transfer Capacitance	Crss			23	-		
Total Gate Charge	Qg		-	16	-		
Gate-Source Charge	Q _{gs}	VDS=50V , VGS=10V , ID=10A		2.5	-	nC	
Gate-Drain Charge	Q _{gd}			2.6	-		
Switching Characteristics							
Turn-On Delay Time	T _{d(on)}		-	5	-		
Rise Time	Tr	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	-	21	-	nS	
Turn-Off Delay Time	T _{d(off)}	VDD=50V VGS=10V , RG=3Ω, ID=10A	-	24	-	113	
Fall Time	T _f	1		3	-	1	
Diode Characteristics							
Diode Forward Voltage	V _{SD}	VGS=0V , IS=1A , TJ=25℃	-	-	1.2	V	
Maximum Body-Diode Continuous Current	Is		-	-	10	Α	
Reverse Recovery Time	T _{rr}	I _S =10A, di/dt=100A/us, TJ=25℃		27	-	nS	
Reverse Recovery Charge	Qrr			21	-	nC	

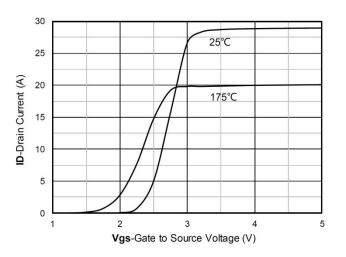
Note:

^{1.} The EAS test condition is VDD=50V,VGS=10V,L=0.5mH,RG=25 Ω



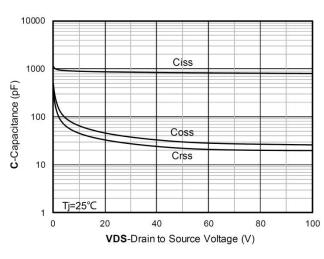
Typical Characteristics

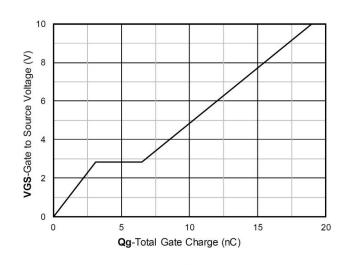




Output Characteristics

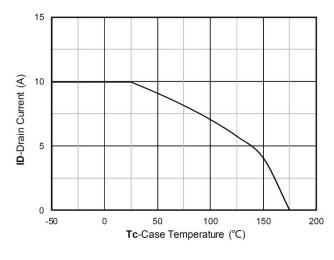


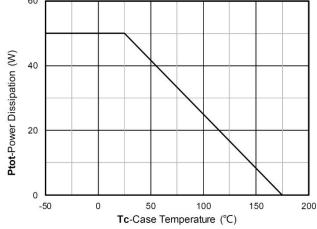




Capacitance Characteristics

Gate Charge 60

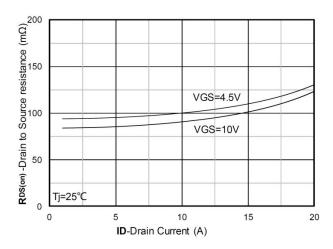




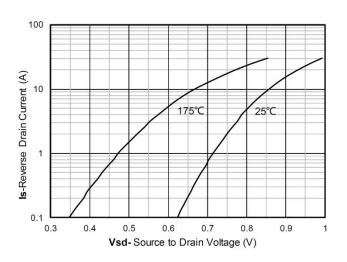
Current dissipation

Power dissipation

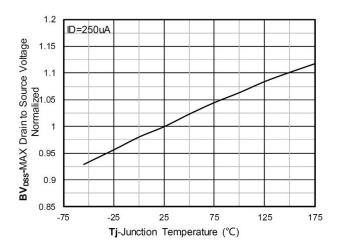




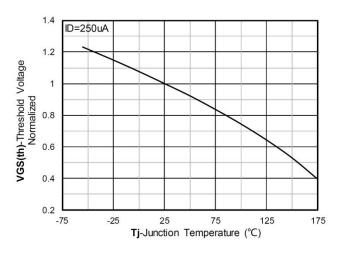
RDS(on) VS Drain Current



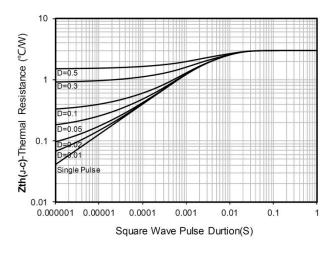
Forward characteristics of reverse diode



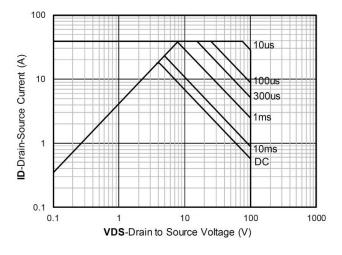
Normalized breakdown voltage



Normalized Threshold voltage

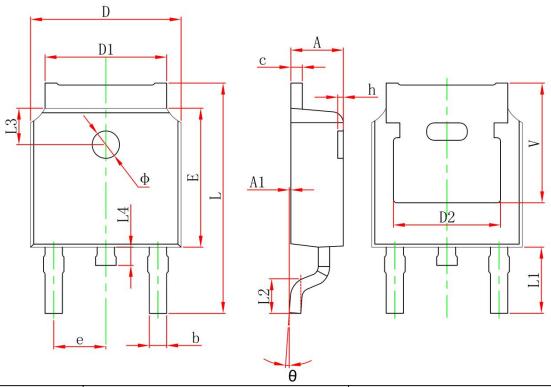


Maximum Transient Thermal Impedance



Safe Operation Area

TO-252 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.830	4.830 REF.		REF.	
Е	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900 REF.		0.114 REF.		
L2	1.400	1.700	0.055	0.067	
L3	1.600 REF.		0.063 REF.		
L4	0.600	1.000	0.024	0.039	
Ф	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.350 REF.		0.211 F	REF.	